



**Advanced Power
Electronics Corp.**

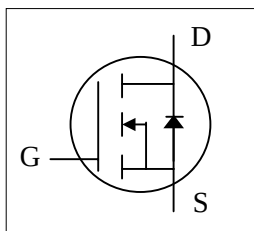
AP75T10GS/P

Pb Free Plating Product

N-CHANNEL ENHANCEMENT MODE

POWER MOSFET

- ▼ Simple Drive Requirement
- ▼ Lower On-resistance
- ▼ Fast Switching Characteristic

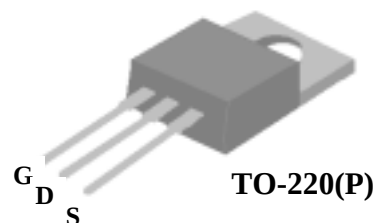
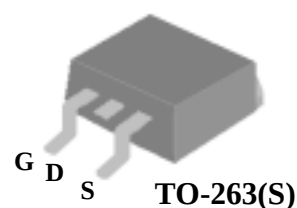


BV_{DSS}	100V
$R_{DS(ON)}$	15m Ω
I_D	72A

Description

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-263 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters. The through-hole version (AP75T10GP) are available for low-profile applications.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ\text{C}$	Continuous Drain Current, V_{GS} @ 10V	72	A
$I_D@T_C=100^\circ\text{C}$	Continuous Drain Current, V_{GS} @ 10V	45	A
I_{DM}	Pulsed Drain Current ¹	260	A
$P_D@T_C=25^\circ\text{C}$	Total Power Dissipation	138	W
	Linear Derating Factor	1.11	W/ $^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Value	Units
Rthj-c	Thermal Resistance Junction-case	Max. 0.9	$^\circ\text{C}/\text{W}$
Rthj-a	Thermal Resistance Junction-ambient	Max. 62	$^\circ\text{C}/\text{W}$



AP75T10GS/P

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =1mA	100	-	-	V
ΔBV _{DSS} /ΔT _j	Breakdown Voltage Temperature Coefficient	Reference to 25°C, I _D =1mA	-	0.09	-	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =30A	-	-	15	mΩ
		V _{GS} =4.5V, I _D =16A	-	-	21	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	-	3	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =30A	-	52	-	S
I _{DSS}	Drain-Source Leakage Current (T _j =25°C)	V _{DS} =100V, V _{GS} =0V	-	-	10	uA
	Drain-Source Leakage Current (T _j =150°C)	V _{DS} =80V, V _{GS} =0V	-	-	100	uA
I _{GSS}	Gate-Source Leakage	V _{GS} = ±20V	-	-	±100	nA
Q _g	Total Gate Charge ²	I _D =30A	-	69	110.4	nC
Q _{gs}	Gate-Source Charge	V _{DS} =80V	-	12	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =4.5V	-	39	-	nC
t _{d(on)}	Turn-on Delay Time ²	V _{DS} =50V	-	12	-	ns
t _r	Rise Time	I _D =30A	-	75	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =10Ω, V _{GS} =10V	-	220	-	ns
t _f	Fall Time	R _D =1.6Ω	-	250	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	5690	9100	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	540	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	310	-	pF
R _g	Gate Resistance	f=1.0MHz	-	1.1	-	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ²	I _S =30A, V _{GS} =0V	-	-	1.3	V
t _{rr}	Reverse Recovery Time ²	I _S =30A, V _{GS} =0V	-	51	-	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	74	-	nC

Notes:

- 1.Pulse width limited by safe operating area.
- 2.Pulse width ≤300us , duty cycle ≤2%.

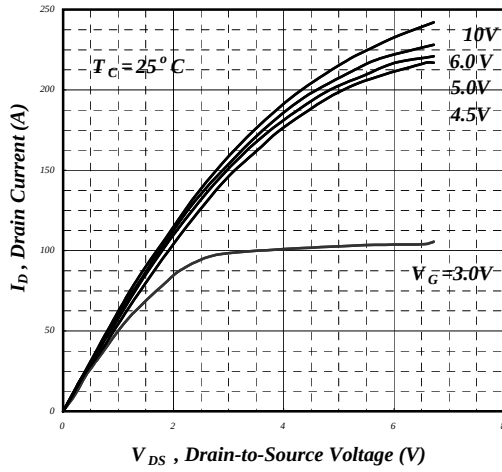


Fig 1. Typical Output Characteristics

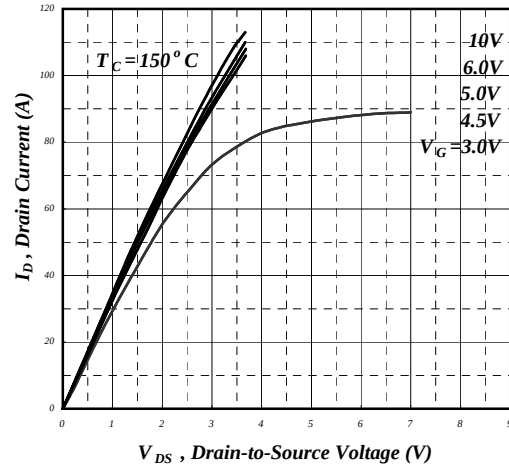


Fig 2. Typical Output Characteristics

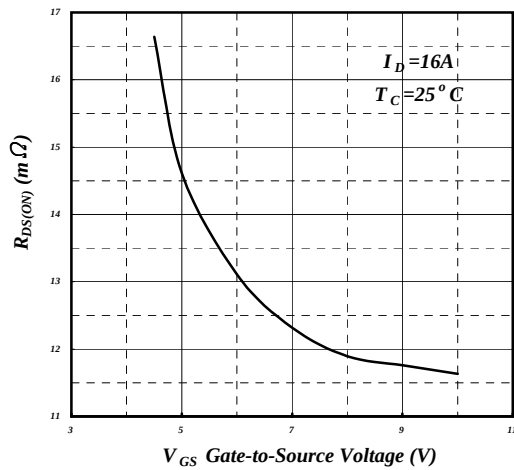


Fig 3. On-Resistance v.s. Gate Voltage

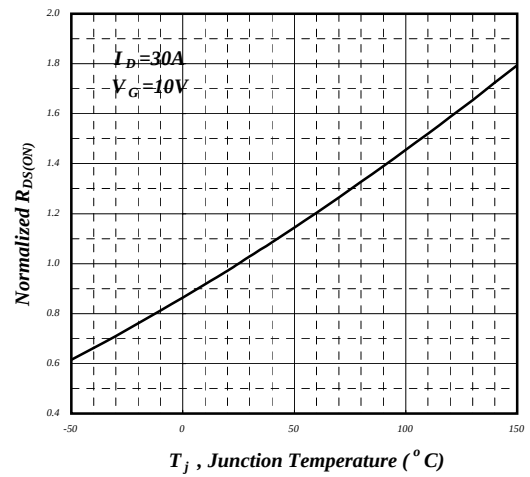


Fig 4. Normalized On-Resistance v.s. Junction Temperature

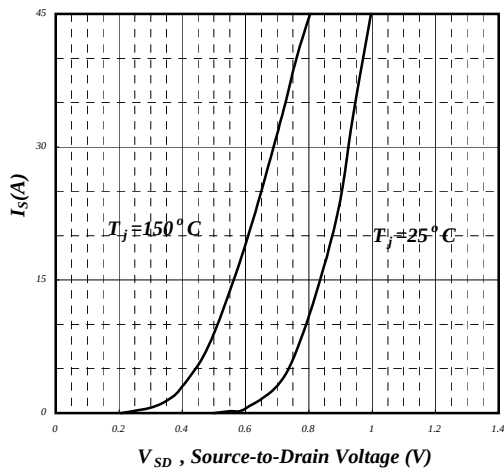


Fig 5. Forward Characteristic of Reverse Diode

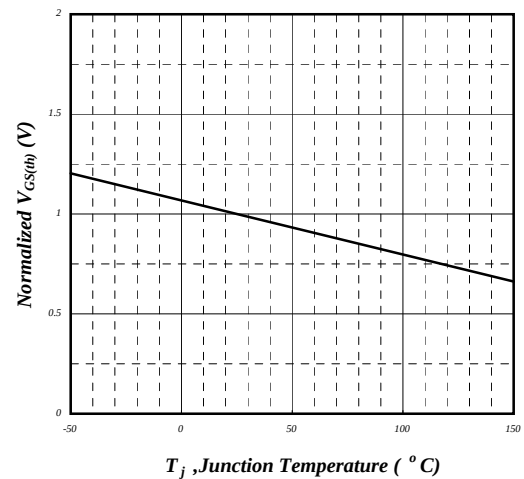


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

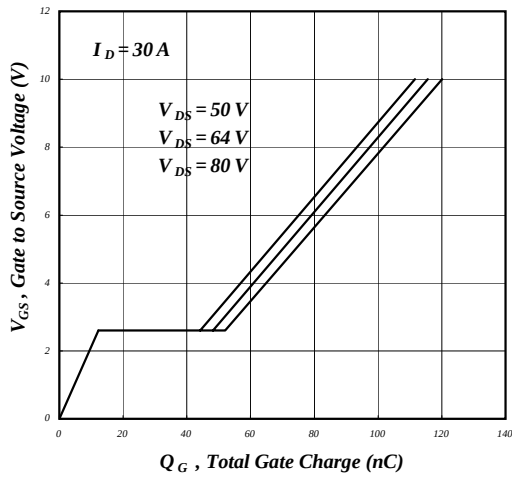


Fig 7. Gate Charge Characteristics

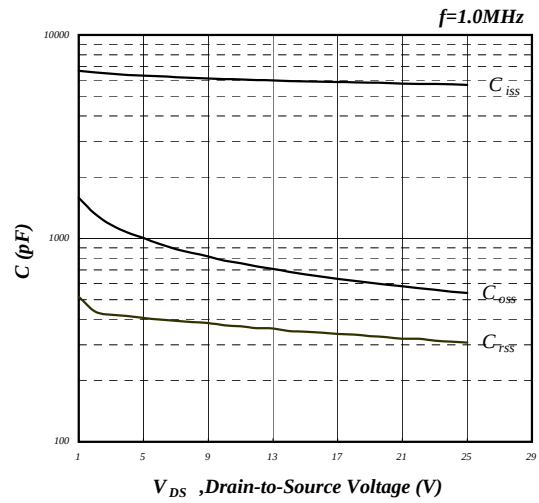


Fig 8. Typical Capacitance Characteristics

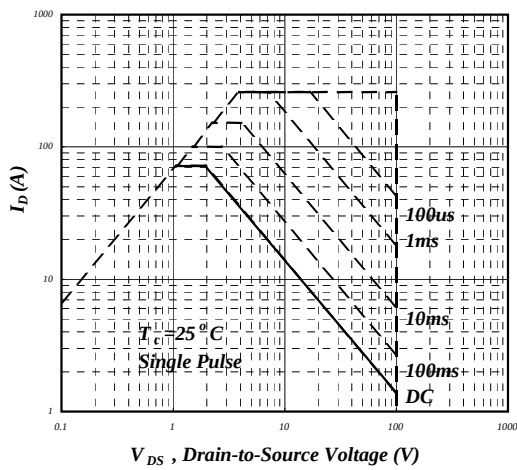


Fig 9. Maximum Safe Operating Area

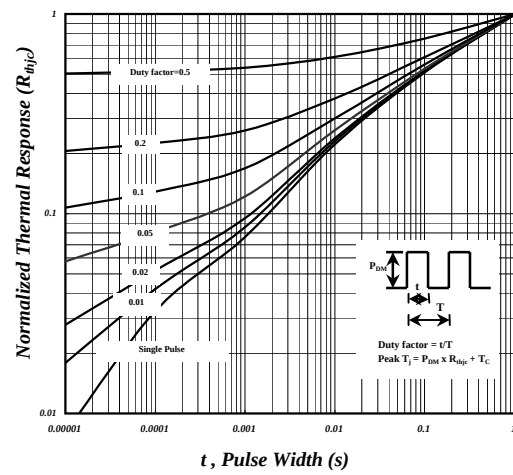


Fig 10. Effective Transient Thermal Impedance

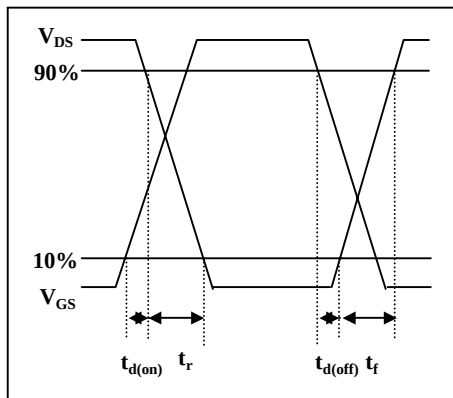


Fig 11. Switching Time Waveform

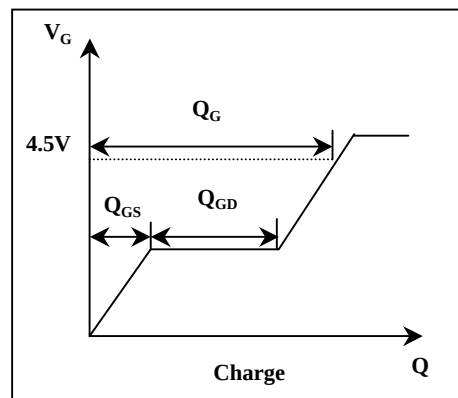


Fig 12. Gate Charge Waveform

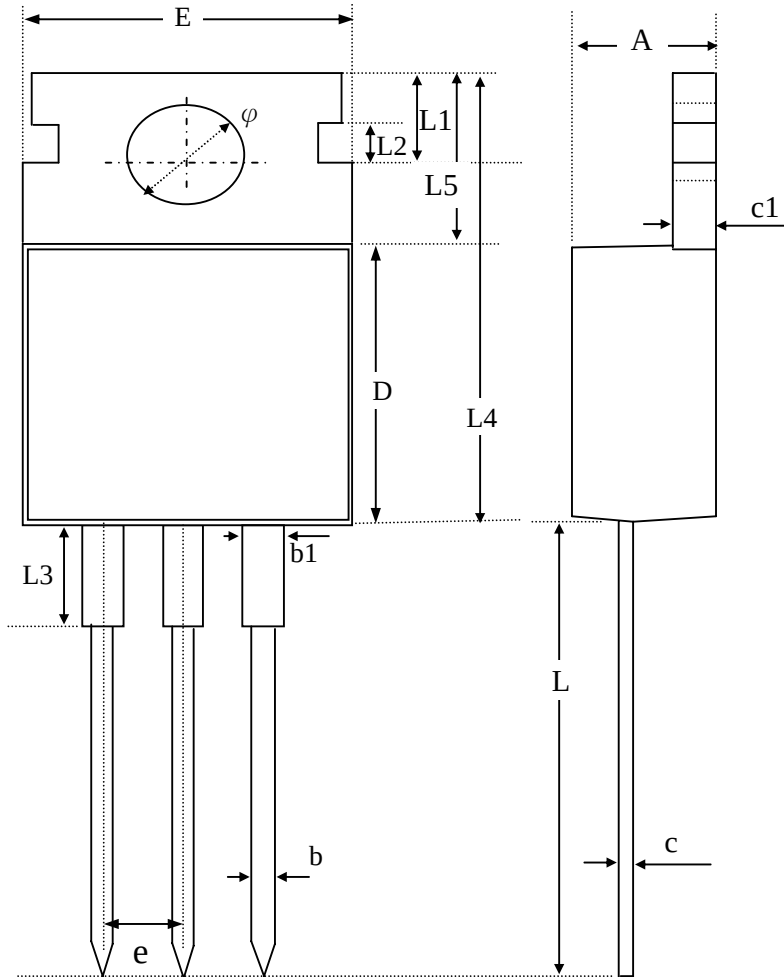


富鼎先進電子股份有限公司

ADVANCED POWER ELECTRONICS CORP.

產品尺寸圖

Package Outline : TO-220



SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	4.25	4.48	4.70
b	0.65	0.80	0.90
b1	1.15	1.38	1.60
c	0.40	0.50	0.60
c1	1.00	1.20	1.40
E	9.70	10.00	10.40
e	----	2.54	----
L	12.70	13.60	14.50
L1	2.60	2.80	3.00
L2	1.00	1.40	1.80
L3	2.6	3.10	3.6
L4	14.70	15.50	16
L5	6.30	6.50	6.70
ϕ	3.50	3.60	3.70
D	8.40	8.90	9.40

1.All Dimensions Are in Millimeters.

2.Dimension Does Not Include Mold Protrusions.

5.2.1 管條(TUBE)之裝箱法

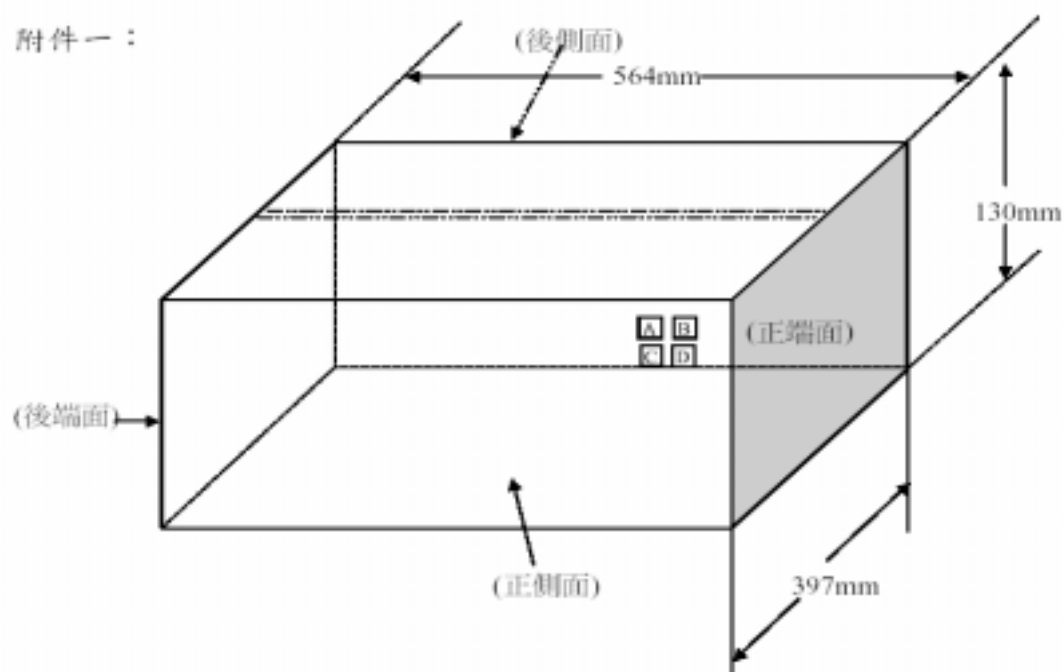
5.2.1.1

產品型式	TO-220	TO-220FM	TO-262	DIP-8
單管數量	50ea	50ea	50ea	50ea
內盒數量	1000ea/Box	1000ea/Box	1000ea/Box	3000ea/Box
外箱數量	6000ea/carton	6000ea/carton	6000ea/carton	12000ea/carton
外箱尺寸	附件(一)	附件(一)	附件(一)	附件(五)

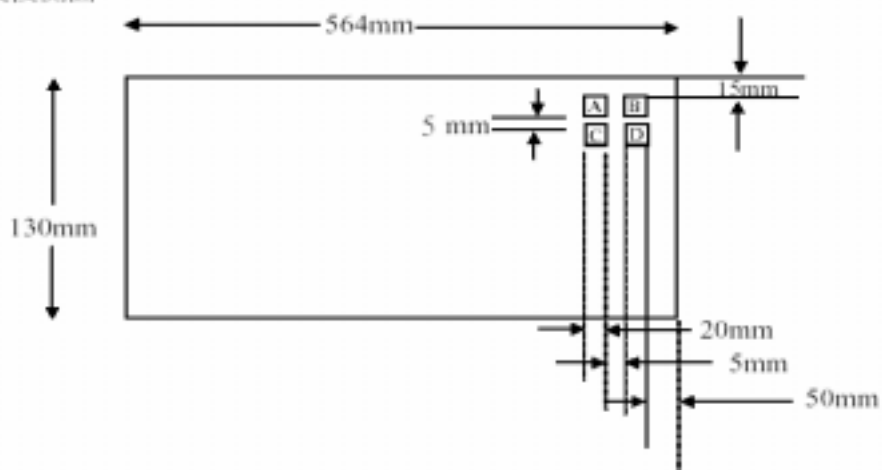
5.2.1.2 尾數箱裝箱時需將剩餘空間，以小內盒或氣泡膠填充之。

TO-220、TO-220FM & TO-262外箱尺寸規格(For Tube)

附件一：



(一)正側面及後側面

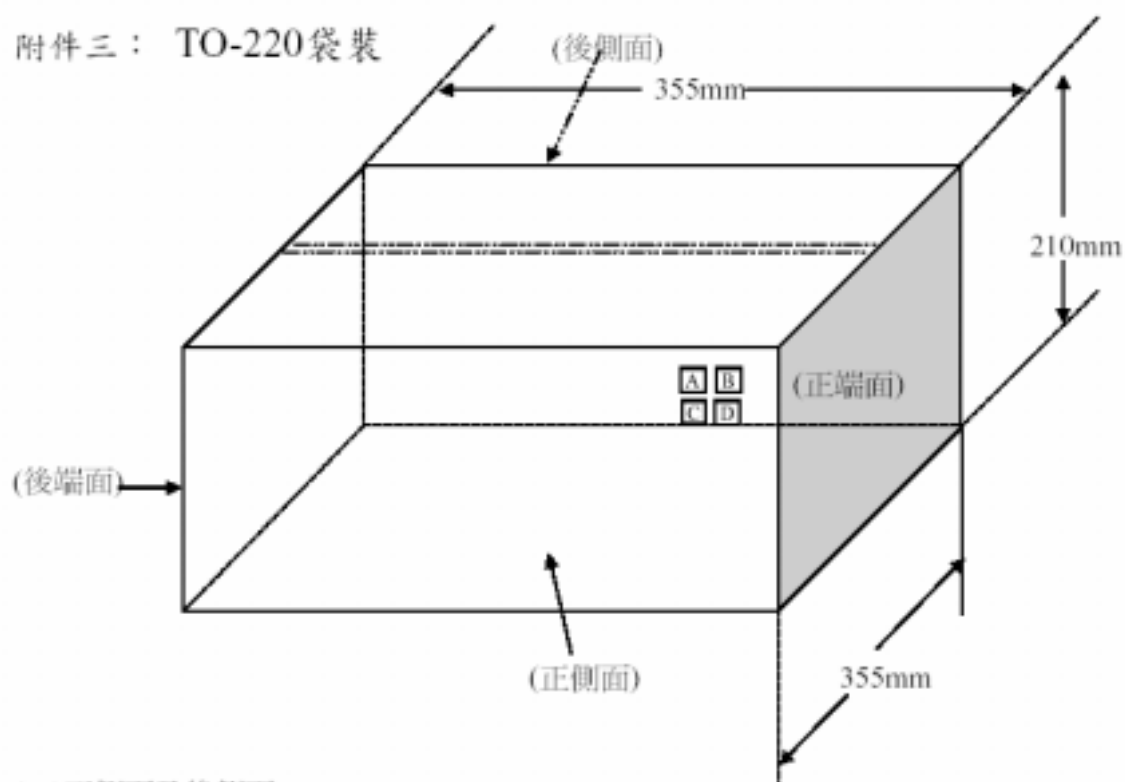


5.2.3 靜電袋之裝箱法

產品型式	TO-220	TO-251/TO-92
單包數量	50ea	100ea
內盒數量	500ea/box	10000ea/box
外箱數量	4000ea/carton	40000ea/carton
外箱尺寸	附件(三)	附件(四)

5.2.3.2 尾數箱裝箱時需將剩餘空間，以小內盒氣泡膠填充之。

附件三： TO-220袋裝



(一)正側面及後側面

